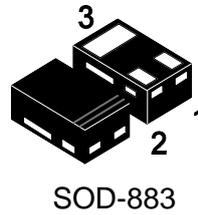
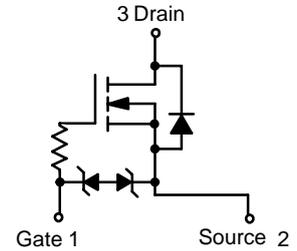


N-channel Trench MOSFET
FEATURE

- Lead Free Product is Acquired
- Surface Mount Package
- N-Channel Switch with Low $R_{DS(on)}$
- Operated at Low Logic Level Gate Drive
- ESD Protected Gate


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APPLICATION

- Load/ Power Switching
- Interfacing Switching
- Battery Management for Ultra Small Portable Electronics
- Logic Level Shift

$V_{(BR)DSS}$	$R_{DS(on)MAX}$	I_D
20V	250mΩ@4.5V	1A
	300mΩ@2.5V	
	400mΩ@1.8V	

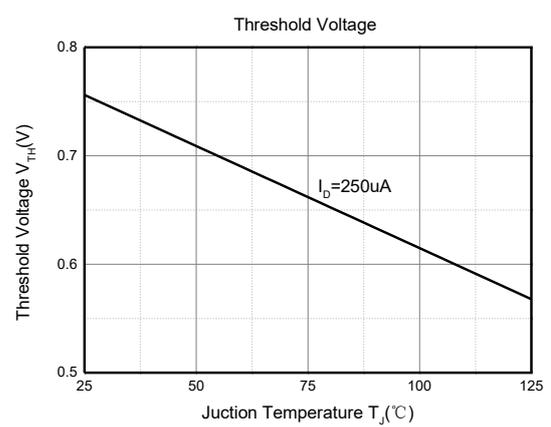
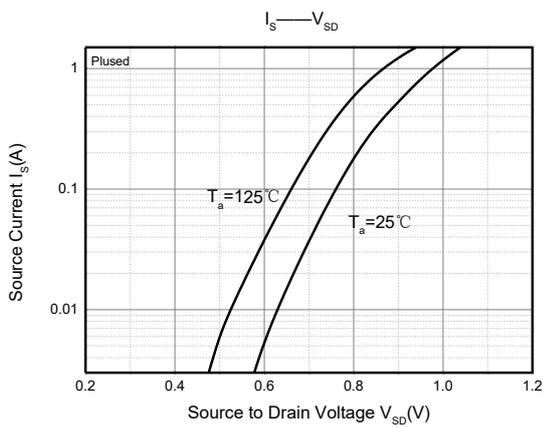
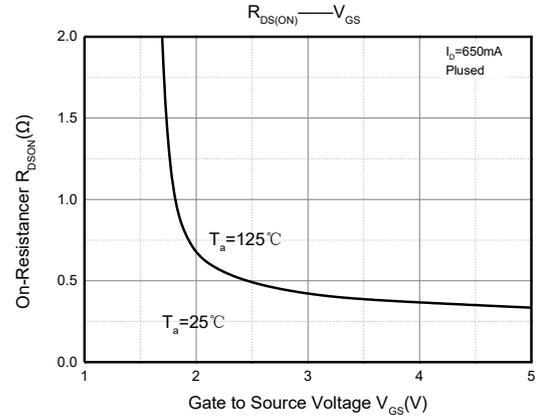
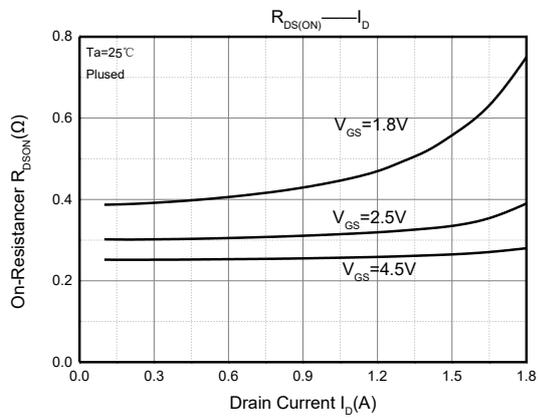
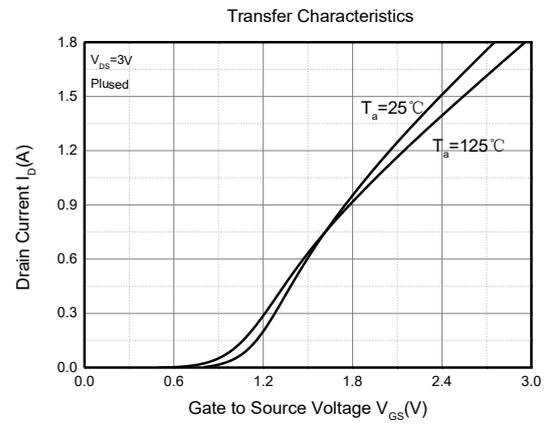
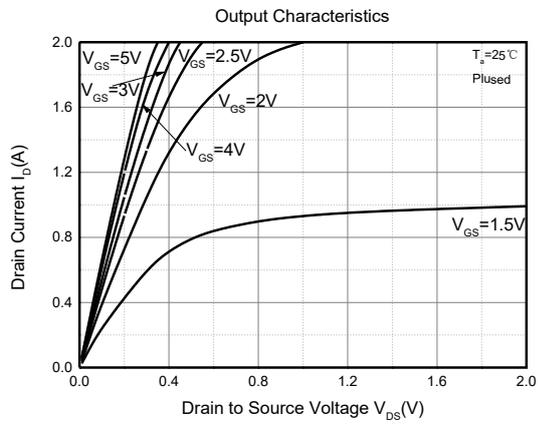
Absolute Maximum Ratings (TA=25°C unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	20	V
Typical Gate-Source Voltage	V_{GS}	±8	V
Continuous Drain Current (note 1)	I_D	0.8	A
Pulsed Drain Current (tp=10us)	I_{DM}	1.8	A
Power Dissipation (note 1)	P_D	100	mW
Thermal Resistance from Junction to Ambient (note 1)	$R_{θJA}$	1250	°C/W
Operation Junction and Storage Temperature Range	T_J, T_{STG}	-55~ 150	°C
Lead Temperature for Soldering Purposes(1/8" from case for 10 s)	T_L	260	°C

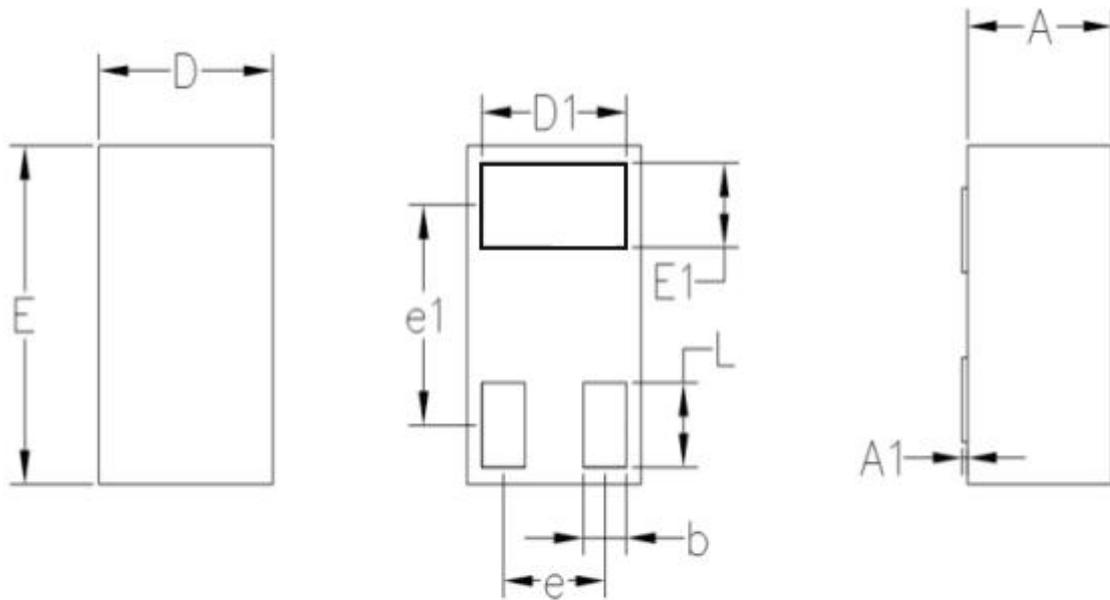
Electrical Characteristics (TA=25°C unless otherwise specified)

Parameter	Symbol	Test Condition	Min	Type	Max	Unit
Static Characteristics						
Drain-source breakdown voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	20			V
Zero gate voltage drain current	I_{DSS}	$V_{DS} = 20V, V_{GS} = 0V$			1	μA
Gate-body leakage current	I_{GSS}	$V_{GS} = \pm 10V, V_{DS} = 0V$			± 20	μA
Gate threshold voltage ⁽²⁾	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	0.4	0.7	1.0	V
Drain-source on-resistance ⁽²⁾	$R_{DS(on)}$	$V_{GS} = 4.5V, I_D = 500mA$		220	400	m Ω
		$V_{GS} = 2.5V, I_D = 500mA$		280	500	
Forward tranconductance	g_{FS}	$V_{DS} = 10V, I_D = 150mA$	150			mS
Dynamic characteristics⁽⁴⁾						
Input Capacitance	C_{iss}	$V_{DS} = 16V, V_{GS} = 0V, f = 1MHz$		79	120	pF
Output Capacitance	C_{oss}			13	20	
Reverse Transfer Capacitance	C_{rss}			9	15	
Switching Characteristics⁽⁴⁾						
Turn-on delay time ⁽³⁾	$t_{d(on)}$	$V_{DS} = 10V, I_D = 500mA,$ $V_{GS} = 4.5V, R_G = 10\Omega$		6.7		ns
Turn-on rise time ⁽³⁾	t_r			4.8		
Turn-off delay time ⁽³⁾	$t_{d(off)}$			17.3		
Turn-off fall time ⁽³⁾	t_f			7.4		
Source-Drain Diode characteristics						
Diode Forward voltage ⁽³⁾	V_{DS}	$I_S = 0.15A, V_{GS} = 0V$			1.2	V

Typical Characteristics



SOD-883 Package Outline Drawing



SYMBOL	DIMENSIONS IN MM		
	MIN	NOM	MAX
A	0.45	0.50	0.55
A1	0.00	—	0.05
D	0.55	0.60	0.65
E	0.95	1.00	1.05
D1	0.45	0.50	0.55
E1	0.20	0.25	0.30
L	0.20	0.25	0.30
b	0.10	0.15	0.20
e	0.35BSC		
e1	0.65BSC		